

Glenn Parsons
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Chair, IEEE 802.1 WG

Re: Market Usage of TSN Features

Dear Mr. Parsons:

We at the Avnu Alliance wish to thank you for your liaison response of November 10, 2016. We are pleased to hear that IEEE 802.1 is investigating how to address cut-through in the IEEE802 standards. Unfortunately, we did not receive your request for contributions at the January IEEE 802.1 Interim meeting until the meeting was underway. Therefore, we were not prepared to contribute to the discussion.

Likewise, we are grateful for the summary of concerns presented by Pat Thaler during that meeting (<http://ieee802.org/1/files/public/docs2017/new-tsn-thaler-cut-through-issues-0117-v01.pdf>). We remain convinced that standardized management of cut-through is in the best interest of our membership and associated markets. Therefore, we respectfully request the opportunity to continue the dialog at the upcoming IEEE802 Plenary session in Vancouver, BC. A copy of our contribution is attached.

We thank you for your efforts thus far and look forward to continued cooperation with IEEE802.

Respectfully submitted,

Kevin Stanton, Chair, Avnu Alliance
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